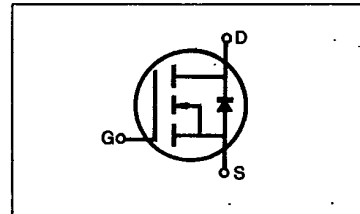
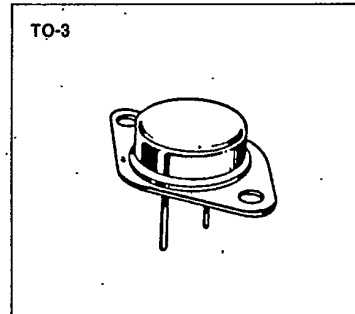


IRF420/421/422/423**N-CHANNEL
POWER MOSFETS****FEATURES**

- Low $R_{DS(on)}$ at high voltage
- Improved inductive ruggedness
- Excellent high voltage stability
- Fast switching times
- Rugged polysilicon gate cell structure
- Low input capacitance
- Extended safe operating area
- Improved high temperature reliability
- TO-3 package (High voltage)

**PRODUCT SUMMARY**

Part Number	V_{DS}	$R_{DS(on)}$	I_D
IRF420	500V	3.0 Ω	2.5A
IRF421	450V	3.0 Ω	2.5A
IRF422	500V	4.0 Ω	2.0A
IRF423	450V	4.0 Ω	2.0A

MAXIMUM RATINGS

Characteristic	Symbol	IRF420	IRF421	IRF422	IRF423	Unit
Drain-Source Voltage (1)	V_{DS}	500	450	500	450	Vdc
Drain-Gate Voltage ($R_{GS}=1.0M\Omega$) (1)	V_{DGR}	500	450	500	450	Vdc
Gate-Source Voltage	V_{GS}	± 20				Vdc
Continuous Drain Current $T_C=25^\circ C$	I_D	2.5	2.5	2.0	2.0	Adc
Continuous Drain Current $T_C=100^\circ C$	I_D	1.5	1.5	1.0	1.0	Adc
Drain Current—Pulsed (3)	I_{DM}	10	10	8.0	8.0	Adc
Gate Current—Pulsed	I_{GM}	± 1.5				Adc
Total Power Dissipation @ $T_C=25^\circ C$ Derate above $25^\circ C$	P_D	40 0.32				Watts W/ $^\circ C$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-55 to 150				$^\circ C$
Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5 seconds	T_L	300				$^\circ C$

Notes: (1) $T_J=25^\circ C$ to $150^\circ C$

(2) Pulse test: Pulse width $\leq 300\mu s$, Duty Cycle $\leq 2\%$

(3) Repetitive rating: Pulse width limited by max. junction temperature

IRF420/421/422/423**N-CHANNEL
POWER MOSFETS****ELECTRICAL CHARACTERISTICS** ($T_C=25^\circ\text{C}$ unless otherwise specified)

Characteristic	Symbol	Type	Min	Typ	Max	Units	Test Conditions
Drain-Source Breakdown Voltage	BV_{DSS}	IRF420 IRF422	500	—	—	V	$V_{GS}=0V$
		IRF421 IRF423	450	—	—	V	$I_D=250\mu A$
Gate Threshold Voltage	$V_{GS(th)}$	ALL	2.0	—	4.0	V	$V_{DS}=V_{GS}$, $I_D=250\mu A$
Gate-Source Leakage Forward	I_{GSS}	ALL	—	—	100	nA	$V_{GS}=20V$
Gate-Source Leakage Reverse	I_{GSS}	ALL	—	—	-100	nA	$V_{GS}=-20V$
Zero Gate Voltage Drain Current	I_{DSS}	ALL	—	—	250	μA	$V_{DS}=\text{Max. Rating}$, $V_{GS}=0V$
			—	—	1000	μA	$V_{DS}=\text{Max. Rating}\times 0.8$, $V_{GS}=0V$, $T_C=125^\circ\text{C}$
On-State Drain-Source Current (2)	$I_{D(on)}$	IRF420 IRF421	2.5	—	—	A	$V_{DS}>I_{D(on)}\times R_{DS(on) \text{ max.}}$, $V_{GS}=10V$
		IRF422 IRF423	2.0	—	—	A	
Static Drain-Source On-State Resistance (2)	$R_{DS(on)}$	IRF420 IRF421	—	2.5	3.0	Ω	$V_{GS}=10V$, $I_D=1.0A$
		IRF422 IRF423	—	3.0	4.0	Ω	
Forward Transconductance (2)	g_{fs}	ALL	1.0	1.75	—	Ω	$V_{DS}>I_{D(on)}\times R_{DS(on) \text{ max.}}$, $I_D=1.0A$
Input Capacitance	C_{iss}	ALL	—	300	600	pF	$V_{GS}=0V$, $V_{DS}=25V$, $f=1.0\text{MHz}$
Output Capacitance	C_{oss}	ALL	—	75	150	pF	
Reverse Transfer Capacitance	C_{rss}	ALL	—	20	40	pF	
Turn-On Delay Time	$t_{d(on)}$	ALL	—	—	60	ns	$V_{DD}=0.5BV_{DSS}$, $I_D=1.0A$, $Z_O=50\Omega$, (MOSFET switching times are essentially independent of operating temperature.)
Rise Time	t_r	ALL	—	—	50	ns	
Turn-Off Delay Time	$t_{d(off)}$	ALL	—	—	60	ns	
Fall Time	t_f	ALL	—	—	30	ns	
Total Gate Charge (Gate-Source Plus Gate-Drain)	Q_g	ALL	—	11	15	nC	$V_{GS}=10V$, $I_D=3.0A$, $V_{DS}=0.8 \text{ Max. Rating}$ (Gate charge is essentially independent of operating temperature.)
Gate-Source Charge	Q_{gs}	ALL	—	5.0	—	nC	
Gate-Drain ("Miller") Charge	Q_{gd}	ALL	—	6.0	—	nC	

THERMAL RESISTANCE

Junction-to-Case	R_{thJC}	ALL	—	—	3.12	K/W	
Case-to-Sink	R_{thCS}	ALL	—	0.1	—	K/W	Mounting surface flat, smooth, and greased
Junction-to-Ambient	R_{thJA}	ALL	—	—	30	K/W	Free Air Operation

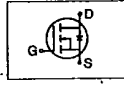
Notes: (1) $T_J=25^\circ\text{C}$ to 150°C (2) Pulse test: Pulse width $\leq 300\mu s$, Duty Cycle $\leq 2\%$

(3) Repetitive rating: Pulse width limited by max. junction temperature

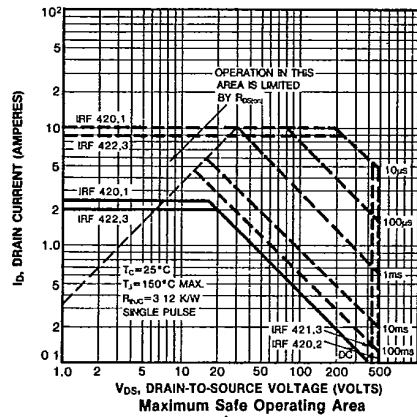
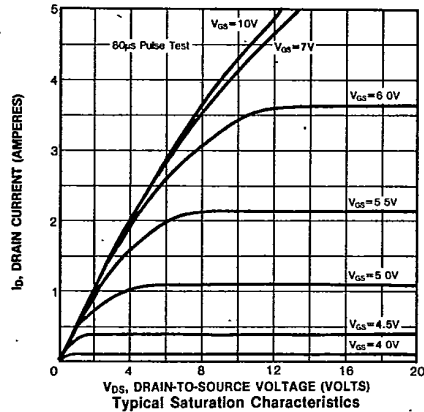
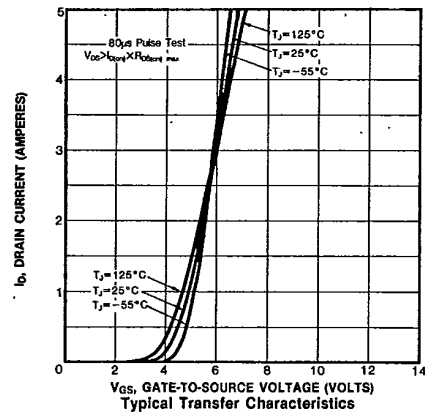
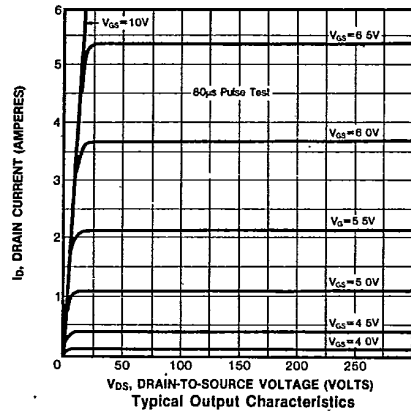
IRF420/421/422/423

**N-CHANNEL
POWER MOSFETS**

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

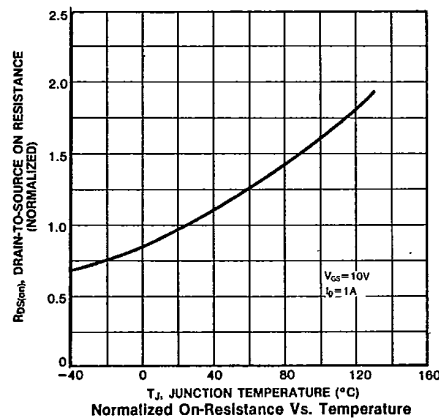
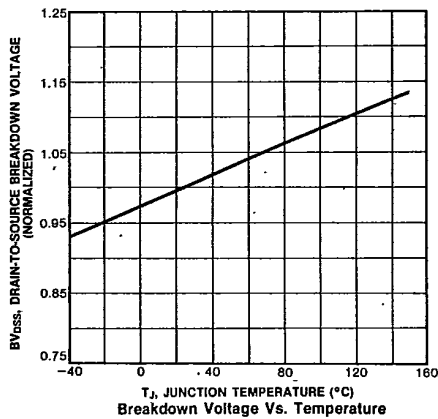
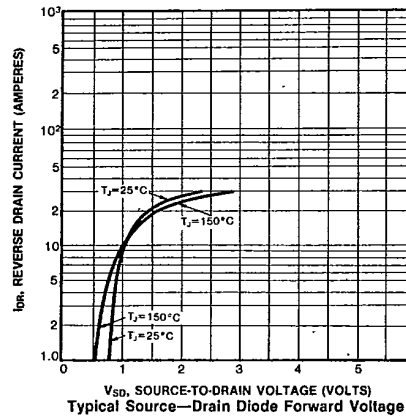
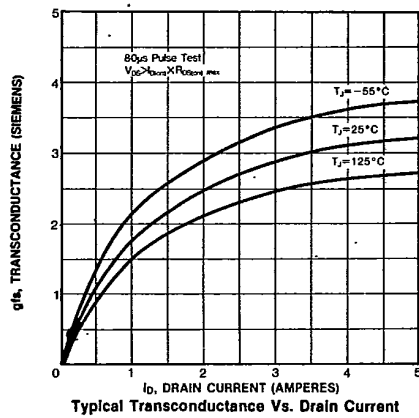
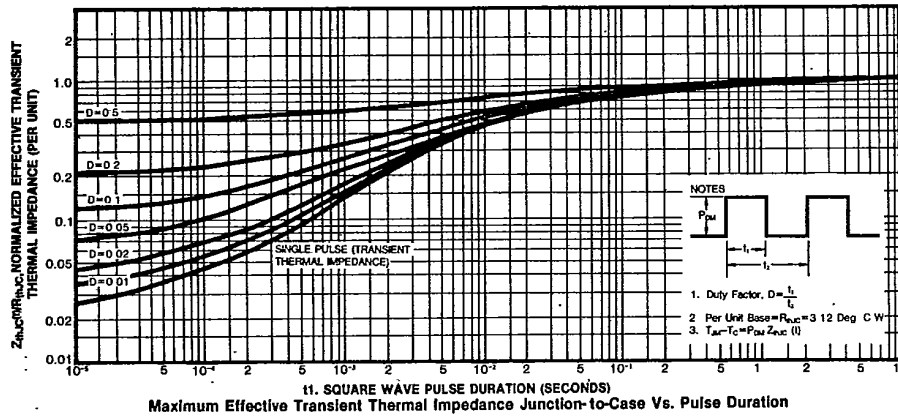
Characteristic	Symbol	Type	Min	Typ	Max	Units	Test Conditions
Continuous Source Current (Body Diode)	I _S	IRF420 IRF421	—	—	2.5	A	Modified MOSFET symbol showing the integral reverse P-N junction rectifier. 
		IRF422 IRF423	—	—	2.0	A	
Pulse Source Current (Body Diode) (3)	I _{SM}	IRF420 IRF421	—	—	10	A	
		IRF422 IRF423	—	—	8.0	A	
Diode Forward Voltage (2)	V _{SD}	IRF420 IRF421	—	—	1.4	V	T _C =25°C, I _S =2.5A, V _{GS} =0V
		IRF422 IRF423	—	—	1.3	V	T _C =25°C, I _S =2.0A, V _{GS} =0V
Reverse Recovery Time	t _{rr}	ALL	—	600	—	ns	T _J =150°C, I _F =2.5A, di/dt=100A/μs

Notes: (1) T_J=25°C to 150°C (2) Pulse test: Pulse width ≤ 300μs, Duty Cycle ≤ 2%
(3) Repetitive rating: Pulse width limited by max. junction temperature



IRF420/421/422/423

N-CHANNEL
POWER MOSFETS



IRF420/421/422/423

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